

UNISONIC TECHNOLOGIES CO., LTD

UT2N20M Preliminary POWER MOSFET

2.0A, 200V N-CHANNEL POWER MOSFET

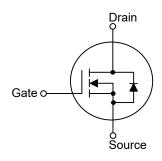
■ DESCRIPTION

The UTC **UT2N20M** is a high voltage power MOSFET combines advanced trench MOSFET designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and high rugged avalanche characteristics. This power MOSFET is usually used in high speed switching applications of switching power supplies and adaptors.

■ FEATURES

- * $R_{DS(ON)} \le 650 \text{ m}\Omega$ @ $V_{GS}=10V$, $I_D=1.0A$ $R_{DS(ON)} \le 700 \text{ m}\Omega$ @ $V_{GS}=4.5V$, $I_D=1.0A$
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness

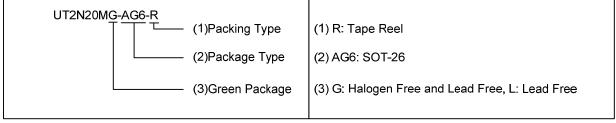
■ SYMBOL



■ ORDERING INFORMATION

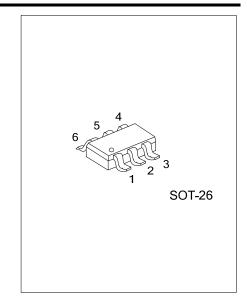
Ordering Number		Darles	Pin Assignment						Da alainan	
Lead Free	Halogen Free	Package	1	2	3	4	5	6	Packing	
UT2N20ML-AG6-R	UT2N20MG-AG6-R	SOT-26	D	D	G	S	D	D	Tape Reel	

Note: Pin Assignment: D: Drain G: Gate S: Source



MARKING





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■ ABSOLUTE MAXIMUM RATING (T_A=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	200	V
Gate-Source Voltage		V _{GSS}	±20	V
Drain Current	Continuous	ID	2	Α
	Pulsed	I _{DM}	4	Α
Peak Diode Recovery dv/dt (Note 3)		dv/dt	1.8	V/ns
Power Dissipation		P _D	1.6	W
Junction Temperature		TJ	+150	°C
Storage Temperature Range		Tstg	-55 ~ +150	°C

- Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
 - 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
 - 3. $I_{SD} \le 2.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J=25^{\circ}C$

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	240	°C/W
Junction to Case	θЈс	78	°C/W

Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

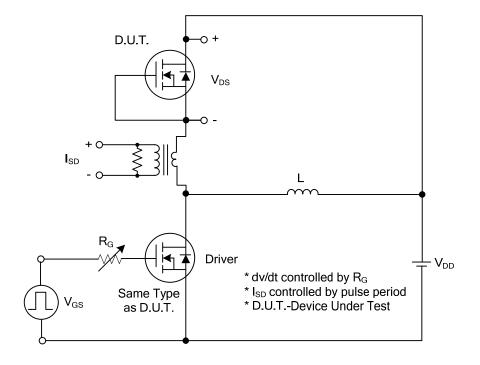
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS				_	_			
Drain-Source Breakdown Voltage		BV _{DSS}	$I_D=250\mu A, V_{GS}=0V$	200			V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} =200V, V _{GS} =0V			10	μΑ	
Forw	vard	Igss	V _{GS} =+20V, V _{DS} =0V			+100	nA	
Gate-Source Leakage Current Reversition	erse		V _{GS} =-20V, V _{DS} =0V			-100	nA	
ON CHARACTERISTICS				_	_	_		
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} =V _{GS} , I _D =250µA	1.0		3.0	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =1.0A			650	mΩ	
			V _{GS} =4.5V, I _D =1.0A			700	mΩ	
DYNAMIC CHARACTERISTICS						-		
Input Capacitance		Ciss			448		pF	
Output Capacitance		Coss	V _{DS} =25V, V _{GS} =0V, f=1MHz		30		pF	
Reverse Transfer Capacitance		Crss			16		рF	
SWITCHING PARAMETERS					-	ā.		
Total Gate Charge (Note 1)		Q_{G}	1/ 100// // 10// 0.04		17		nC	
Gate to Source Charge		Q _{GS}	V _{DS} =160V, V _{GS} =10V, I _D =2.0A		2		nC	
Gate to Drain Charge		Q_{GD}	(Note 1, 2)		4		nC	
Turn-on Delay Time (Note 1)		$t_{D(ON)}$			3		ns	
Rise Time		t_R	V _{DD} =100V, V _{GS} =10V,		17		ns	
Turn-off Delay Time		t _{D(OFF)}	$I_D = 2.0A$, $R_G = 3\Omega$ (Note 1, 2)		15		ns	
Fall-Time		t⊦			19		ns	
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Body-Diode Continuous Current		ls				2	Α	
Maximum Body-Diode Pulsed Current		Ism				4	Α	
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =2.0A, V _{GS} =0V			1.4	V	
Reverse Recovery Time		t _{rr}	I _S =2.0A, V _{GS} =0V,		47		ns	
Reverse Recovery Charge		Qrr	d _{IF} /d _t =100A/µs		67		nC	

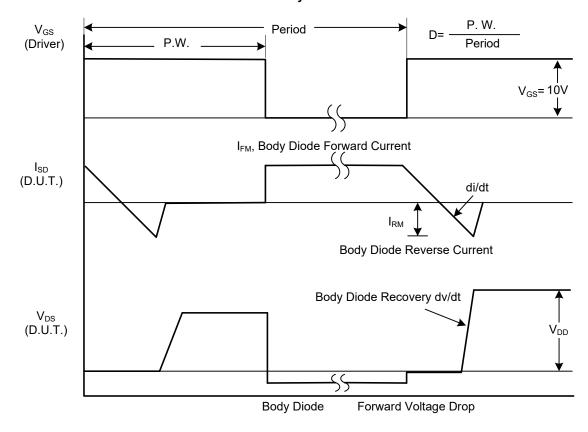
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

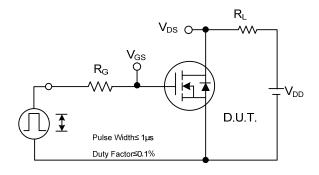


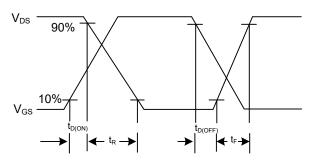
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

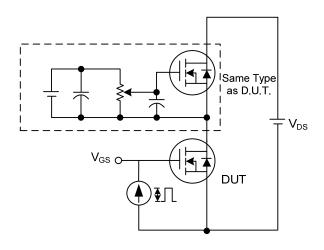
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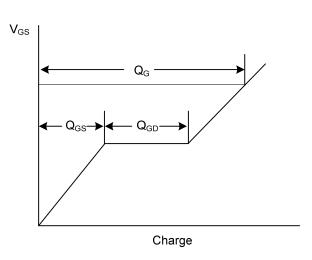




Switching Test Circuit

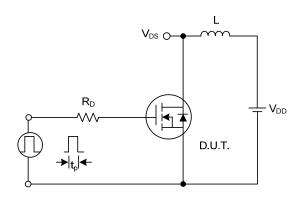
Switching Waveforms

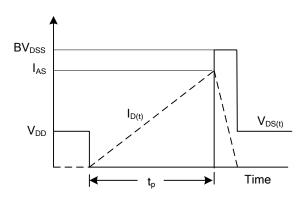




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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